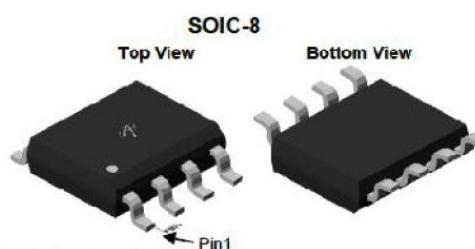


YPN 438S——40V 10A N&P-Channel Power MOSFET (2 IN 1)

General Features

- Proprietary New Trench Technology
- Ultra-low Miller Charge
- N MOS RDS(ON),typ.=18mΩ@V_{GS}=10V
- P MOS RDS(ON),typ.=30mΩ@V_{GS}=10V
- Low Gate Charge Minimize Switching Loss
- Fast Recovery Body Diode

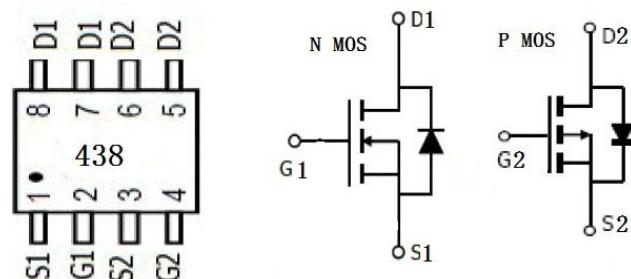


Applications

- High efficiency DC/DC Converters
- Synchronous Rectification
- Motor Drive

Ordering Information

Part Number	Package	Marking
YPN 438S	SOP-8	438



Absolute Maximum Ratings

Absolute Maximum Ratings			$T_A=25^\circ\text{C}$ unless otherwise noted		
Parameter	Symbol		Maximum		Units
			N MOS	P MOS	
Drain-Source Voltage	V_{DS}		+40	-40	V
Gate-Source Voltage	V_{GS}		± 20 V	± 20 V	V
Continuous Drain Current	I_D	$T_A=25^\circ\text{C}$	12.2	-10	A
		$T_A=70^\circ\text{C}$	8.5	-8	
Pulsed Drain Current	I_{DM}		35	-30	
Maximum Power Dissipation			2.5	2.8	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}		-55 to 150		°C

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device

Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	4.0	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	42	

Electrical Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = \pm 250\text{mA}$, $V_{GS} = 0\text{V}$	± 40			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = \pm 40\text{V}$, $V_{GS} = 0\text{V}$			1	μA
I_{GSS}	Gate-Body leakage current	$V_{DS} = 0\text{V}$, $V_{GS} = \pm 20\text{V}$			± 100	nA
On Characteristics (Note 3)						
$V_{GS(\text{th})}$	Gate Threshold Voltage	NMOS: $V_{DS} = V_{GS}$ $I_D = 250\text{mA}$	1	1.5	2.5	V
		PMOS: $V_{DS} = V_{GS}$ $I_D = -250\text{mA}$	-1.1	-1.7	-2.5	
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	NMOS: $V_{GS} = 10\text{V}$, $I_D = 10\text{A}$		15	18	$\text{m}\Omega$
		NMOS: $V_{GS} = 4.5\text{V}$, $I_D = 8\text{A}$		22	35	
		PMOS: $V_{GS} = -10\text{V}$, $I_D = -7.2\text{A}$		27	32	$\text{m}\Omega$
		PMOS: $V_{GS} = -4.5\text{V}$, $I_D = -5.6\text{A}$		32	38	
g_{FS}	Forward Transconductance	NMOS: $V_{DS} = 5\text{V}$, $I_D = 8\text{A}$	13			S
		PMOS: $V_{DS} = -5\text{V}$, $I_D = -5\text{A}$	20			
Drain-Source Diode Characteristics						
V_{SD}	Diode Forward Voltage (Note 3)	NMOS: $V_{GS} = 0\text{V}$, $I_S = 8\text{A}$			1.2	V
		PMOS: $V_{GS} = 0\text{V}$, $I_S = -6\text{A}$				
I_S	Maximum Body-Diode Continuous Current (Note 2)	NMOS			10	A
		PMOS			-6.2	
t_{rr}	Body Diode Reverse Recovery Time	NMOS: $T_J = 25^\circ\text{C}$, $I_F = 10\text{A}$, $dI/dt = 100\text{A}/\mu\text{s}$ (Note 3)		35		ns
		PMOS: $T_J = 25^\circ\text{C}$, $I_F = -7\text{A}$, $dI/dt = 100\text{A}/\mu\text{s}$ (Note 3)		60		
Dynamic Characteristics (Note 4)						
C_{iss}	Input Capacitance	NMOS		500		pf
C_{oss}	Output Capacitance	$V_{DS} = 20\text{V}$, $V_{GS} = 0\text{V}$, $F = 1.0\text{MHz}$		60		
C_{rss}	Reverse Transfer Capacitance			25		
C_{iss}	Input Capacitance	PMOS		1750		
C_{oss}	Output Capacitance	$V_{DS} = -20\text{V}$, $V_{GS} = 0\text{V}$, $F = 1.0\text{MHz}$		215		
C_{rss}	Reverse Transfer Capacitance			180		

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Switching Characteristics (Note 4)						
Q_g	Total Gate Charge	NMOS : $V_{GS}=10V$, $V_{DS}=20V$, $I_D=8A$		14		nC
Q_{gs}	Gate Source Charge			2.9		
Q_{gd}	Gate Drain Charge			5.2		
Q_g	Total Gate Charge	PMOS : $V_{GS}=-10V$, $V_{DS}=-20V$, $I_D=-5A$		24		nC
Q_{gs}	Gate Source Charge			3.5		
Q_{gd}	Gate Drain Charge			6		
$t_{d(on)}$	Turn-On Delay time	NMOS: $V_{DD}=20V, I_D=2A, R_L=6.7\Omega$ $V_{GS}=10V, R_G=3\Omega$		5		ns
t_r	Turn-On Rise Time			2.6		
$t_{d(off)}$	Turn-Off Delay Time			16.1		
t_f	Turn-Off Fall Time			2.3		
$t_{d(on)}$	Turn-On Delay Time	PMOS: $V_{DD}=-20V, I_D=-2A, R_L=2\Omega$ $V_{GS}=-10V, R_{GEN}=3\Omega$		9		ns
t_r	Turn-On Rise Time			8		
$t_{d(off)}$	Turn-Off Delay Time			28		
t_f	Turn-Off Fall Time			10		

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production

Typical Electrical and Thermal Characteristics (Curves):P MOS

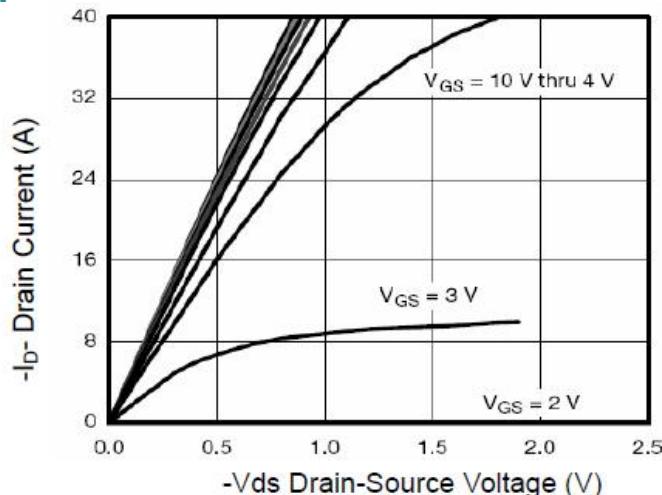


Figure 1 Output Characteristics

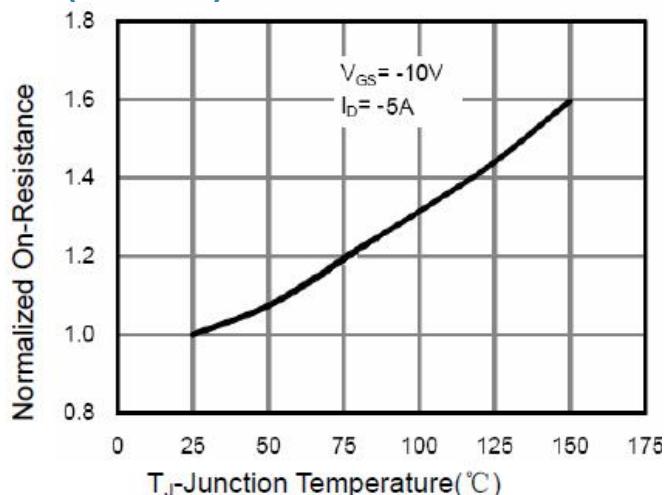


Figure 4 Rdson-Junction Temperature

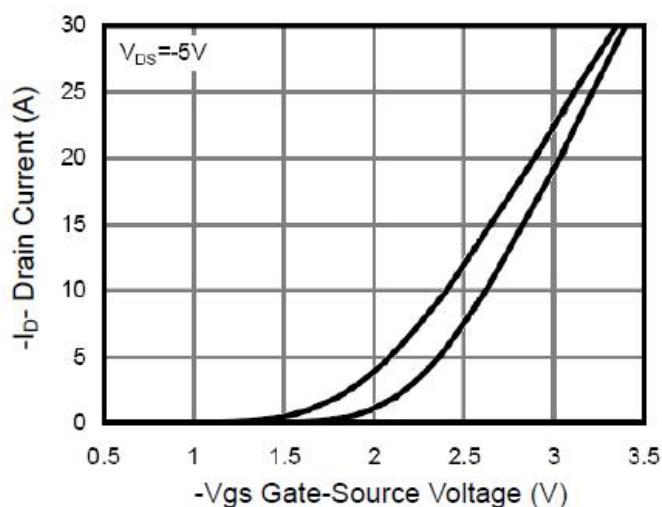


Figure 2 Transfer Characteristics

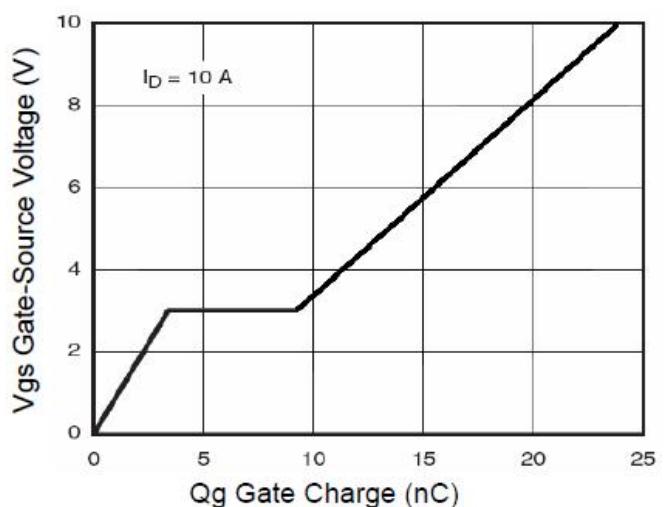


Figure 5 Gate Charge

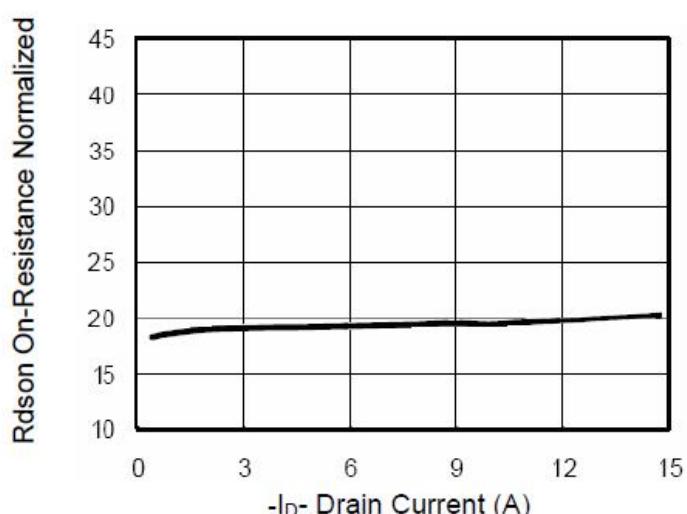


Figure 3 Rdson- Drain Current

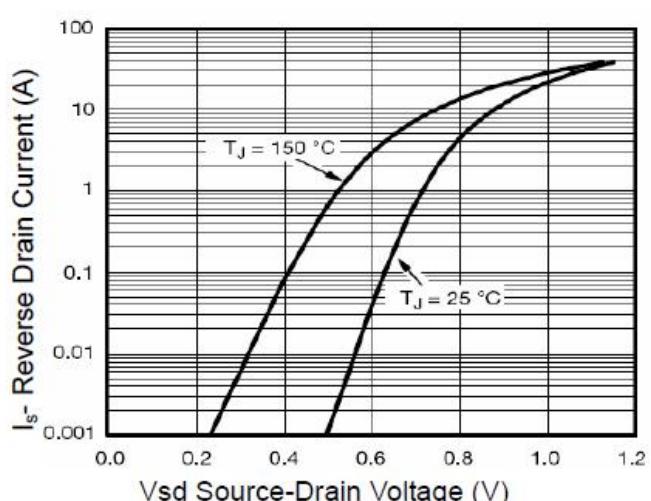


Figure 6 Source- Drain Diode Forward

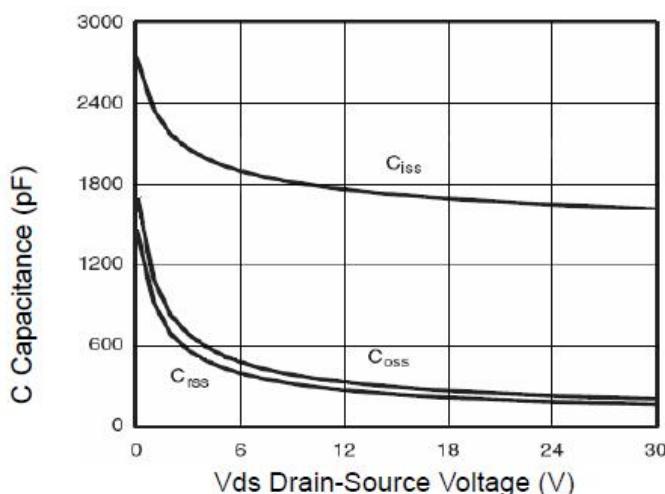


Figure 7 Capacitance vs Vds

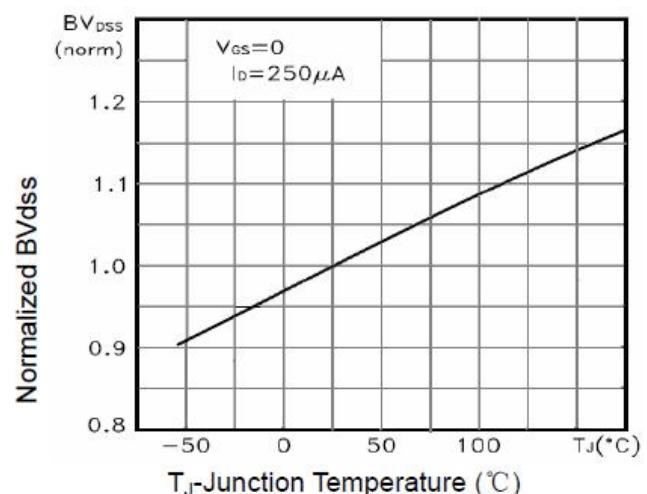


Figure 9 BV_{DSS} vs Junction Temperature

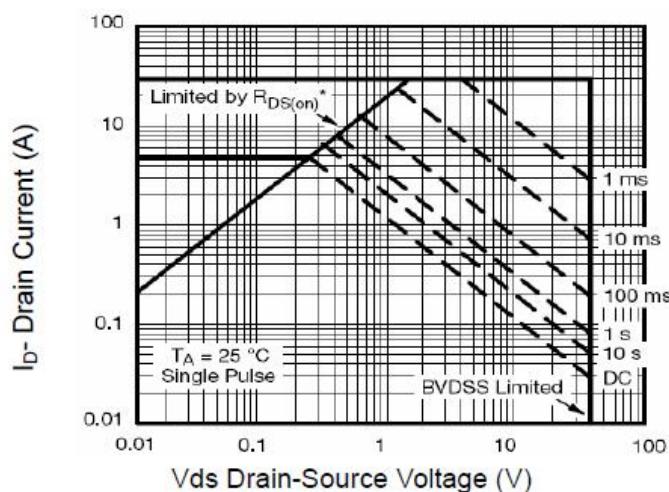


Figure 8 Safe Operation Area

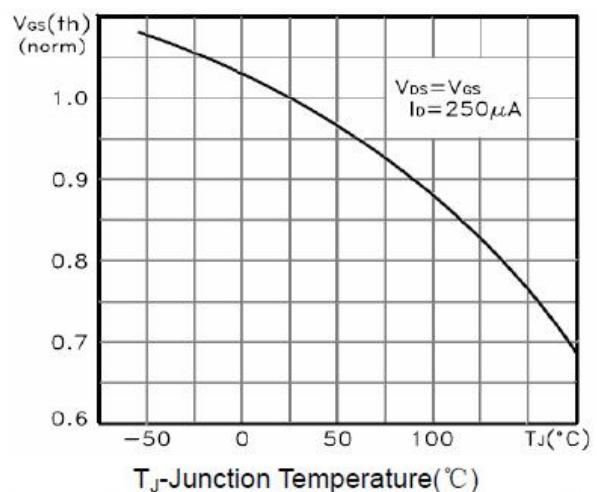


Figure 10 $V_{GS(th)}$ vs Junction Temperature

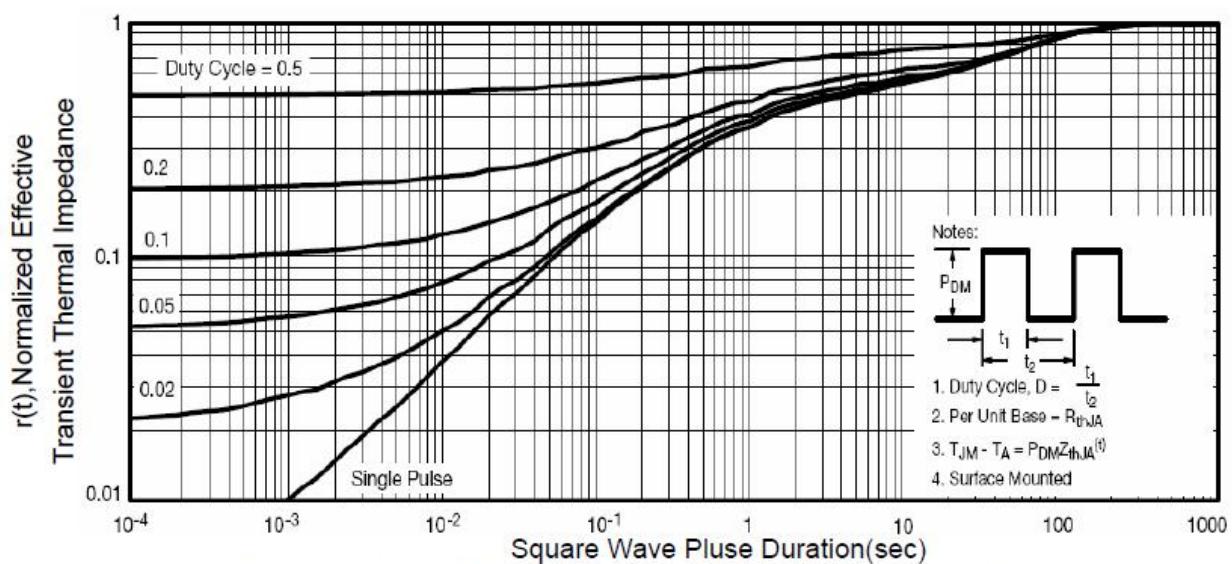


Figure 11 Normalized Maximum Transient Thermal Impedance

Typical Electrical and Thermal Characteristics (Curves):N MOS

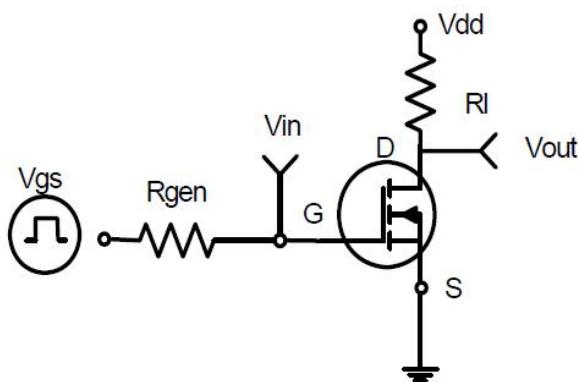


Figure 1:Switching Test Circuit

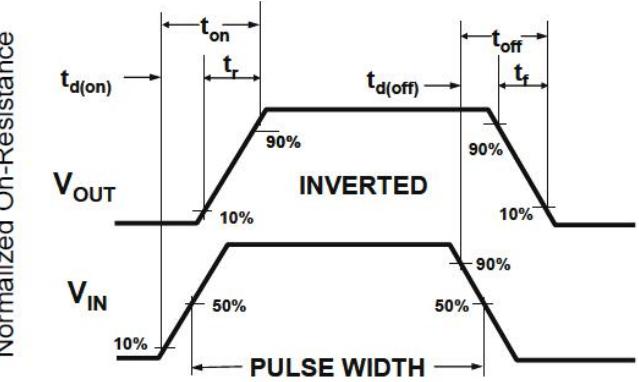


Figure 2:Switching Waveforms

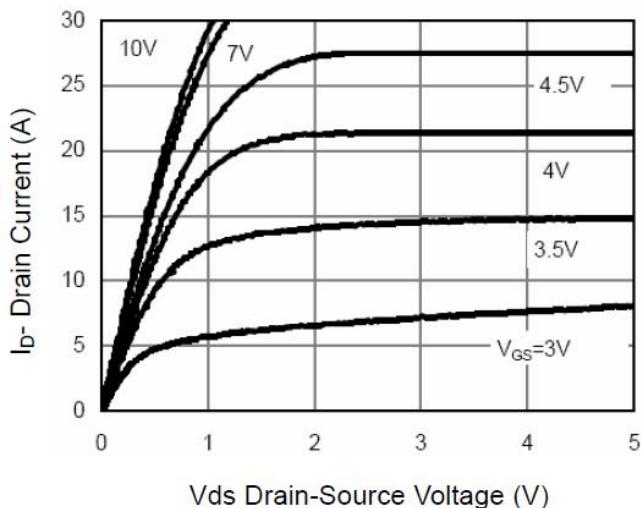


Figure 3 Output Characteristics

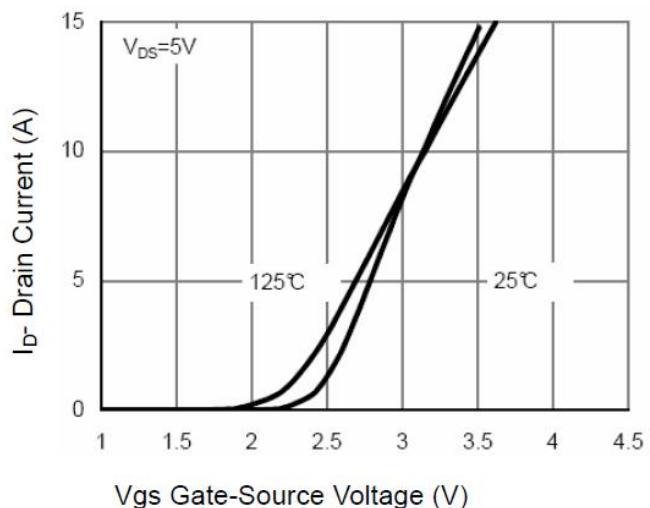


Figure 4 Transfer Characteristics

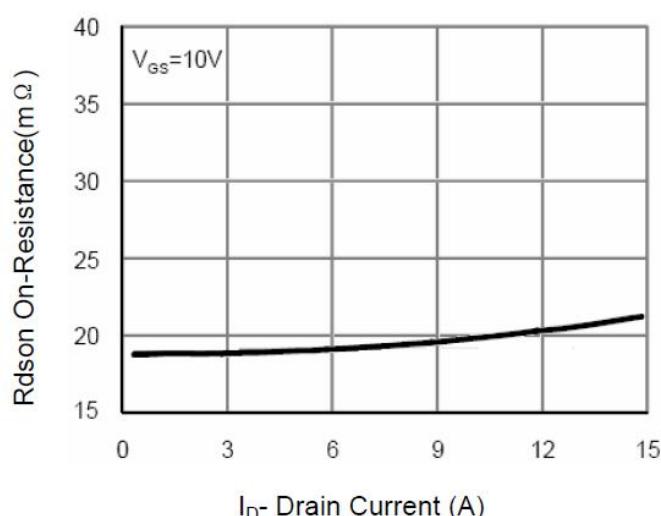


Figure 5 Drain-Source On-Resistance

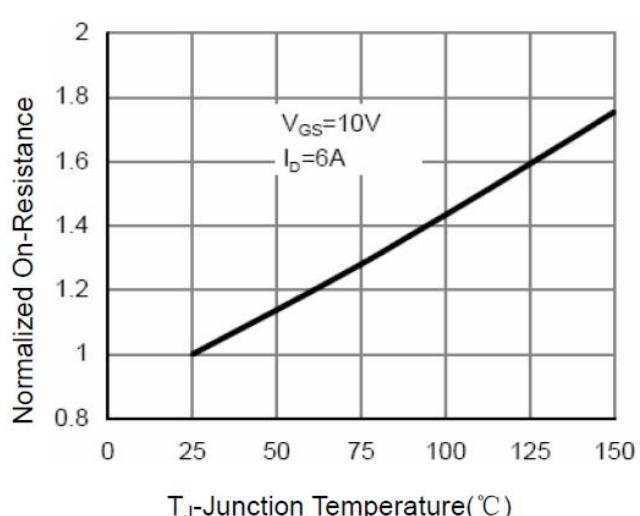


Figure 6 Drain-Source On-Resistance

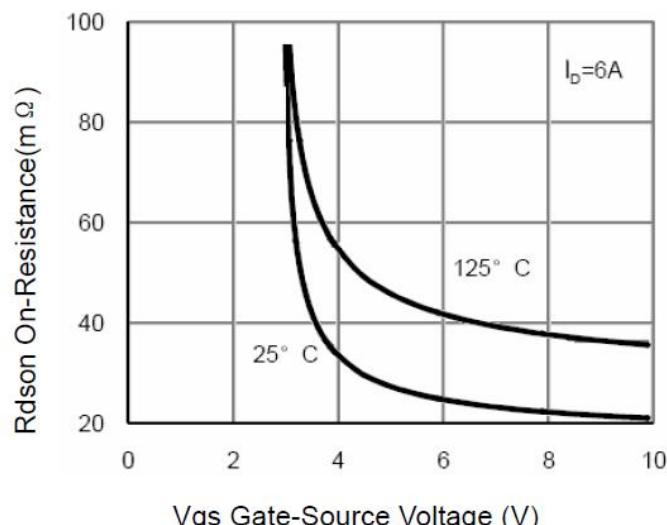


Figure 7 Rdson vs Vgs

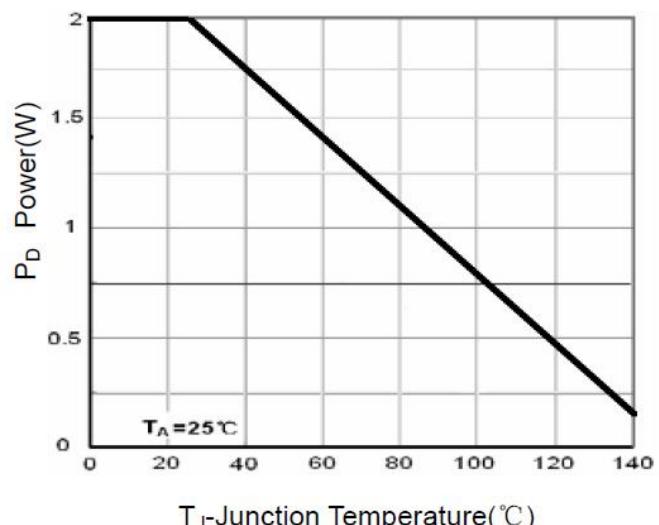


Figure 8 Power Dissipation

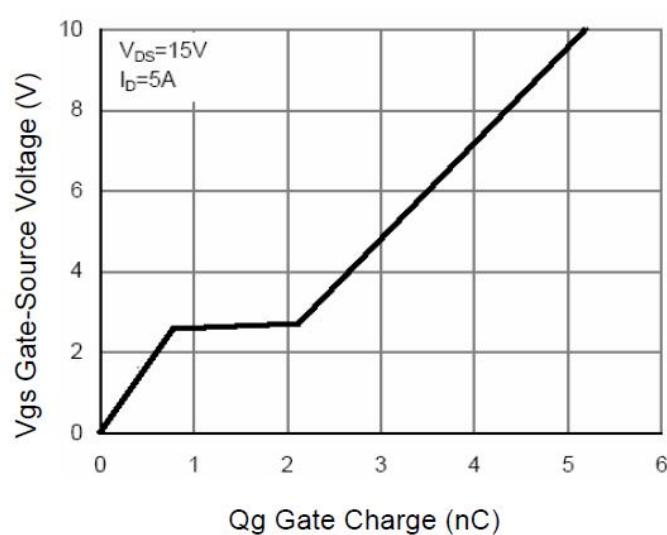


Figure 9 Gate Charge

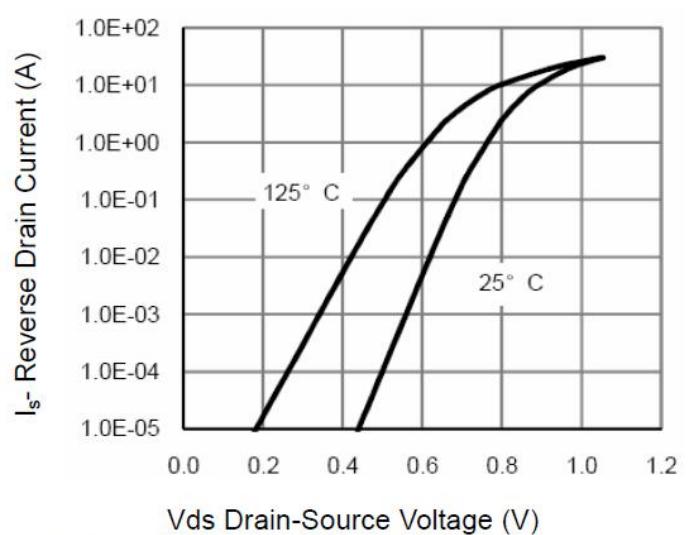


Figure 10 Source- Drain Diode Forward

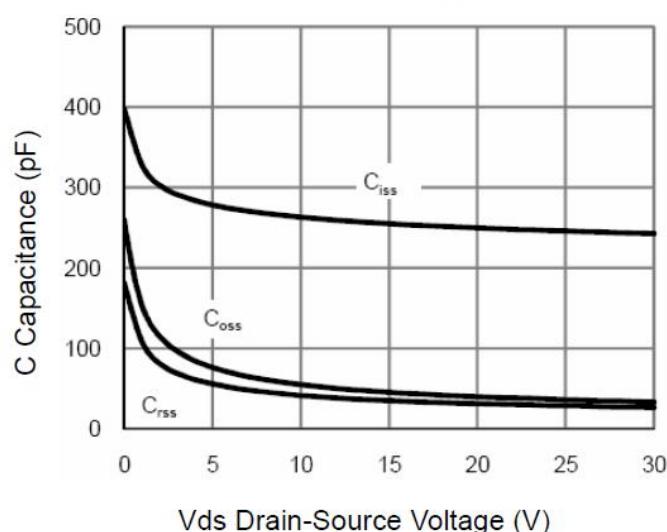


Figure 11 Capacitance vs Vds

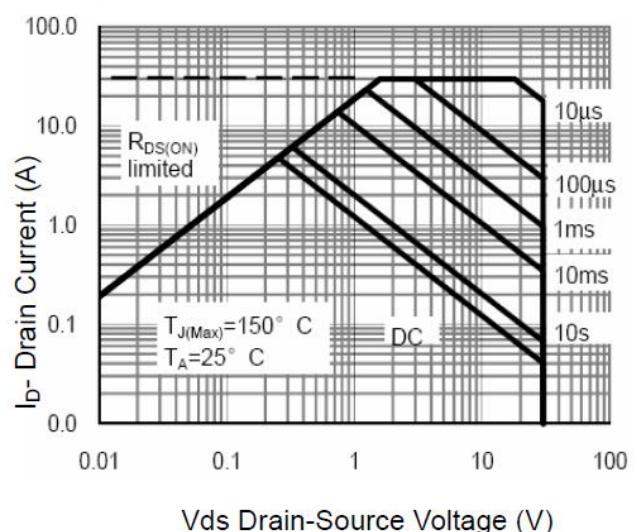


Figure 12 Safe Operation Area

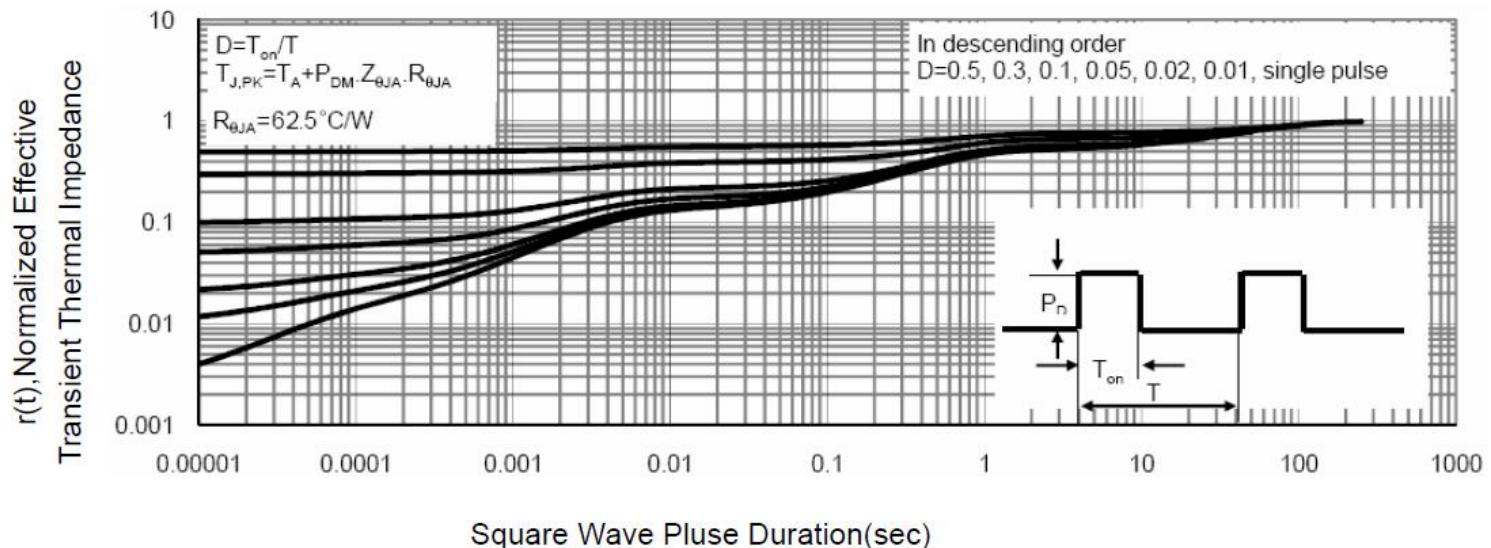
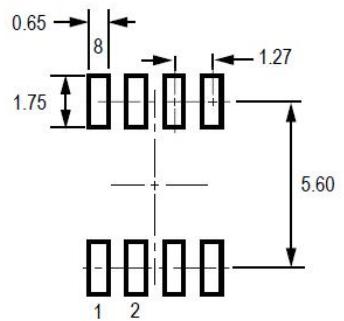
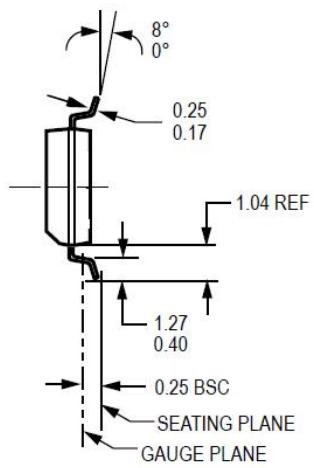
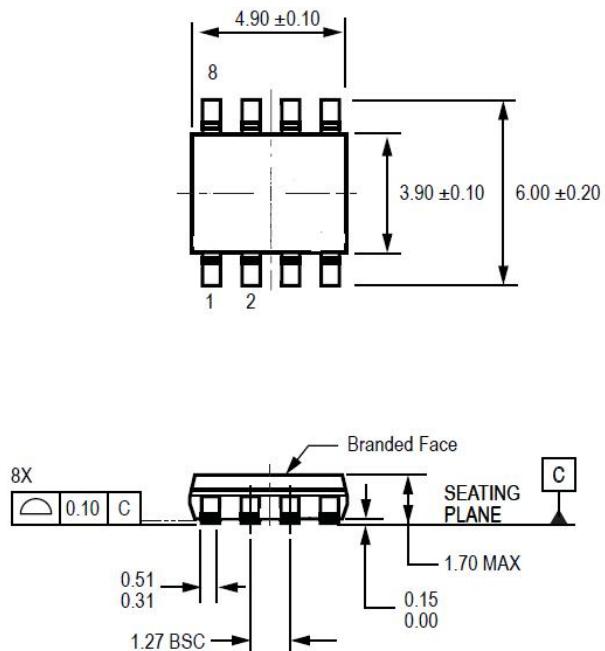


Figure 13 Normalized Maximum Transient Thermal Impedance

Order information:

Order information						
Y	2	N/	6	55	S	()
公司商标代号 Company symbol						
1: NIL ,2:2 MOS						
P: PMOS, N:N MOS						
BVDSS: 6—60V; 10—100V; 20—200V; 35—350V; 40—400V						
RDS(on) : 55—55m Ω ; 38—38m Ω ; 16—16m Ω						
D:DIP; S:SOP						
Special code						

Dimension and PCB layout :



PCB Layout Reference View

Dimensions in millimeters
Dimensions exclusive of mold f
Exact case and lead configurat

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[424134F](#) [026935X](#) [051075F](#) [SBVS138LT1G](#) [614234A](#) [715780A](#) [NTNS3166NZT5G](#) [751625C](#) [873612G](#) [IRF7380TRHR](#)
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